As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled (Insert Title) APPARATUS FOR EVALUATING DETERIORATED STATE OF HYDROCARBON ADSORBENT the specification of which is attached hereto unless the following box is checked: as PCT International Application Number was filed on and/or and was amended on _____ as United States Application Number _ was filed on and was amended on ____ I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56. I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designates at least one country other than the United States. listed below and have also identified below any foreign application(s) for patent or inventor's certificate or PCT International Application having a filing date before that of the application for which priority is claimed: Priority Claimed 5 August 2002 2002-227182 Japan Ž Yes □ No (List prior (Day/Month/Year Filed) (Country) foreign ☐ Yes ☐ No applications. (Day/Month/Year Filed) (Country) See note A ☐ Yes ☐ No on back of (Day/Month/Year Filed) this page) I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below. (Filing Date) (Application Number) (Filing Date) (Application Number) ☐ See attached list for additional prior foreign or provisional applications. (See Note B on back of this page) I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or §365(c) of any PCT International application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) (U.S. or PCT) in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56 which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application: (List prior U.S. Applications or (Application Serial No.) (Fiting Date) (Status) (patented, pending, abandoned) PCT International applications (Filing Date) (Application Serial No.) designating the U.S.) And I hereby appoint as principal attorneys: David T. Nikaido, Reg. No. 22,663; Charles M. Marmelstein, Reg. No. 25,895; George E. Oram, Jr., Reg. No. 27,931; Robert B. Murray, Reg. No. 22,980; E. Marcie Emas, Reg. No. 32,131; Douglas H. Goldhush, Reg. No. 33,125; Monica Chin Kitts, Reg. No. 36,105; Richard J. Berman, Reg. No. 39,107; King L. Wong, Reg. No. 37,500; Karen K. Costantino, Reg. No. 35,107; James A. Poulos, III, Reg. No. 31,714; Patrick D. Muir, Reg. No. 37,403; Sharon N. Klesner, Reg. No. 36,335; and Murat Ozgu, Reg. No. 44,275; Bradley D. Goldizen, Reg. No. 43,637; and N. Alexander Nolte, Reg. No. 45,689. Please direct all communications to the following address: ARENT FOX KINTNER PLOTKIN & KAHN, PLLC 1050 Connecticut Avenue, N.W., Suite 600 Washington, D.C. 20036-5339 Tel: (202) 857-6000; Fax: (202) 857-6395 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor Masaki UENO (See Note C on back of

Full name of sole or first inventor Masaki UENO

Inventor's signature Masaki UENO

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this page)

- A. Please list all non-convention foreign applications relating to the invention (and check block "no"), as well as all convention (priority) applications.
- B. If more than 3 prior foreign applications or 2 provisional applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For the Inventor's "Residence", only the city and state is necessary, however the "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.

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Inventor's signature	
	Date
Residence	
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Full name of fifth joint inventor, if any	
Inventor's signature	
Residence	Date
Citizenship	
Post Office Address	
Full name of single to the second sec	
Full name of sixth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of seventh joint inventor, if any	
Inventor's signature	
Residence	Date
Citizenship	
Post Office Address	
Full name of eighth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	